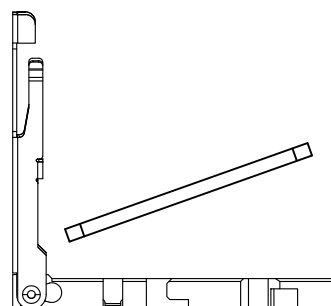
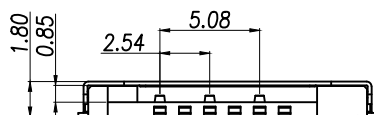
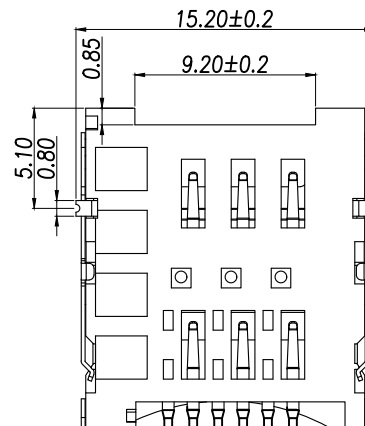
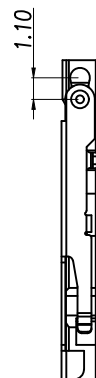
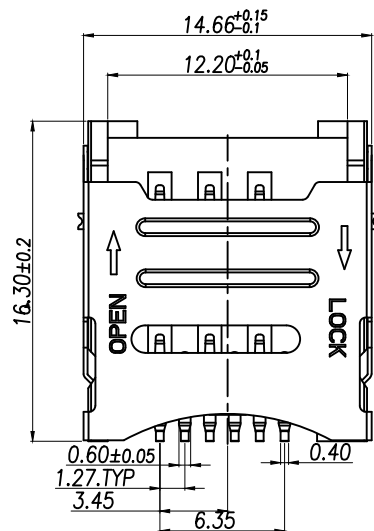
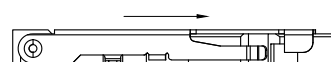




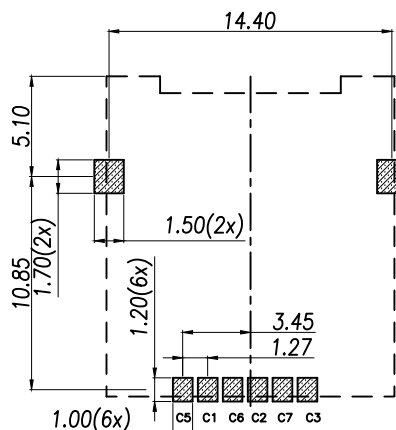
STEP 1 INSERT MICRO SIM CARD



STEP 2 PUSH THE SHELL



STEP 3 FINISH



PAD AREA

KEEP OUT AREA

RECOMMENDED PCB LAYOUT

GENERAL TOLERANCE ±0.05

MICRO SIM CARD	
Pin No.	NAME
C1	VCC OF SIM
C2	RST OF SIM
C3	CLK OF SIM
C5	GND OF SIM
C6	VPP OF SIM
C7	I/O OF SIM
C4/C8	N/A

一、材质和镀层:

1. 胶芯: LCP, UL 94V-0, 黑色

2. 端子: 磷铜C5210-H, T=0.15,

全区镀底30u"MIN

触点镀金GOLD FLASH0.6-1.0u"

焊脚双面镀亮锡50-80u"

3. 定位脚: 磷铜C2680-H, T=0.20,

全区镀底30u"MIN, 镀亮锡50-80u"

4. 外壳: 不锈钢 T=0.2

二、技术参数:

接触电阻: 100MΩ MAX

绝缘阻抗: 1000MΩ MIN(500DC)

额定电流: 每个接触件1A MAX

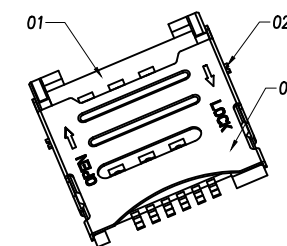
额定电压: 30V MAX(DC)

耐压: 500V R.M.S/MIN

使用温度: -40℃~85℃

湿度: 80% R.H MAX

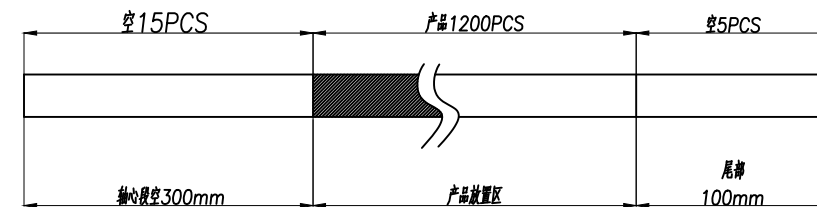
寿命: >3000次



DIMENSION IN mm		厦门市辛译精密电子有限公司 Xiamen XinYi Xyeconn Electronics Co.,Ltd				
TOLERANCE UNLESS OTHERWISE SPECIFIED		APR.	Alex	TITLE: MICRO SIM CARD HINGED 6PIN H1.8 尺寸		
.X±0.5	X.*± 2	CHK.	Jack	DWG NO. XY SIM-01A		
.XX±0.3	.X.*± 1	DRA.	Can	PROJ.	CUSTOMER DRAWING	
.XXX±0.2	.XX*±			SIZE A4	SCALE 1:1	SHEET 1/1

NOTES

- 每卷包装数量:1200PCS/每卷
- 卷带包装方式:



3.每箱包装数量:12000PCS/箱

4.纸箱350mm*350mm*440mm(内部尺寸),材质K=K

上下各1PCS珍珠棉

胶纸工字型封箱

CARTON
350*350*340 K=K

LABEL

DIMENSION IN mm

TOLERANCE UNLESS
OTHERWISE SPECIFIED

.X±0.5

X*±2

APR.

Alex

TITLE:

MICRO SIM CARD HINGED 6PIN H1.8 测试 包装

.XX±0.3

.X*±1

CHK.

Jack

DWG NO.

XY SIM-01A

.XXX±0.2

.XX*±

DRA.

Can

PROJ.

CUSTOMER DRAWING

SIZE A4

SCALE 1:1

SHEET 1/1

REV.

A